

IN THE SPECIFICATION

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The underlying object of the invention is to improve a cutting plate in accordance with ~~the preamble of claim 1~~ the present invention in such a way that processing the cutting-plate upper side by lapping or grinding does not affect the gripping properties of the cutting plate. ~~In~~ plate. In accordance with the invention, this object is achieved by arranging a second clamping trough coaxially with respect to the first clamping trough, with the first clamping trough being arranged so that it is deeper than the second clamping trough and both being arranged so that they are deeper than the cutting-plate upper side. As a result, the vertical spacing of the first clamping trough from the second clamping trough is always the same, even when the cutting-plate upper side is processed by grinding or lapping.